FLIP CHIP MODULES TEST SPECS

TYPE:

R 122A #001 FLIP - FLOP

TEST	CONDITION	MAXIMUM		3/1/66 MINIMUM	
LOWER LEVEL	V = 0.5 V	- 3 3	V	-3,8 V	
LOAD	V = 0	2,2	мА .	1.8	МА
V _{CE}	1 _C = 20 MA V _{IN} = -2.0V	≦ 300	MV	≤ 300	MV
: INPUT CURRENT		1.1	МА	0.8	МА
TOTAL	RISE	≦ 70	NS	≦ 70	NS
TIME	. FALL	≦ 300	NS	≦ 300	NS

TECHNICAL INFORMATION

MAINTENANCE INFORMATION

Repair of printed circuitry should be done with a low voltage, fairly coal soldering iron to prevent damage to the transistors and keep the copper from litting.

Oscilloscopes used to troubleshoot a module or system should be grounded to prevent damaging transients.